

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT5227908

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
DAVID R. GIFFORD	10/25/2018
PATRICE M. PARRIS	10/25/2018
RECEIVING PARTY DATA	
Name:	SILICON SPACE TECHNOLOGY CORPORATION, D.B.A. VORAGO TECHNOLOGIES, INC.
Street Address:	1501 S. MOPAC EXPY., SUITE 350
City:	AUSTIN
State/Country:	TEXAS
Postal Code:	78746
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	16183909
CORRESPONDENCE DATA	
Fax Number:	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	512-825-6582
Email:	katherine@singhlawtx.com
Correspondent Name:	SINGH LAW, PLLC
Address Line 1:	8101 COBBLESTONE DRIVE
Address Line 4:	AUSTIN, TEXAS 78735
ATTORNEY DOCKET NUMBER:	VT1002
NAME OF SUBMITTER:	KATHERINE WILSON
SIGNATURE:	/Katherine Wilson/
DATE SIGNED:	11/08/2018
Total Attachments: 2	
source=VT1002-Assignment-DG-Signed#page1.tif	
source=VT1002-Assignment-PP-Signed#page1.tif	

I David R. Gifford ("ASSIGNOR") am the original inventor or an original joint inventor of subject matter ("INVENTION") disclosed and/or claimed in a patent application entitled "STRUCTURES FOR IMPROVING RADIATION HARDNESS AND ELIMINATING LATCH-UP IN INTEGRATED CIRCUITS" ("APPLICATION"), which:

will be filed; or

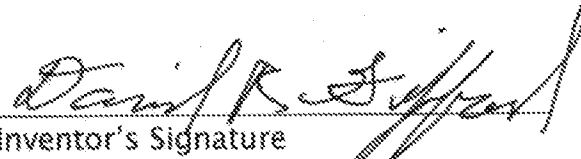
was filed on _____ and was given Application No _____ by the following Office

" _____";

Silicon Space Technology Corporation, a Delaware Corporation, D.B.A. Vorago Technologies, Inc., on behalf of itself and its successors and assigns ("ASSIGNEE"), is entitled to, and is desirous of acquiring, the entire and exclusive rights, title and interest, including the right of priority, in the INVENTION and the APPLICATION (and all other applications and patents derived therefrom, such as continuing applications, in whole or in part, in and for the United States, its territories, and all foreign countries ("APPLICATION DERIVATIVES"));

For good and valuable consideration, the receipt of which is hereby acknowledged by the ASSIGNOR, the ASSIGNOR hereby sells, assigns and transfers to the ASSIGNEE, ASSIGNOR's entire and exclusive rights, title and interest, including the right of priority, in the INVENTION and the APPLICATION (and all other applications and patents derived therefrom, such as continuing applications, in whole or in part, in and for the United States, its territories, and all foreign countries ("APPLICATION DERIVATIVES"));

ASSIGNOR agrees to execute all instruments and documents required for the making and prosecution of the APPLICATION (and APPLICATION DERIVATIVES), for litigation regarding letters patent derived therefrom, and for the purpose of protecting and perfecting title to the APPLICATION (and APPLICATION DERIVATIVES).

	<u>10/25/2018</u>
Inventor's Signature	Date
<u>David R. Gifford</u>	
Printed Name in English	Printed Name in Native Language (if other than English)


I Patrice M. Parris ("ASSIGNOR") am the original inventor or an original joint inventor of subject matter ("INVENTION") disclosed and/or claimed in a patent application entitled "STRUCTURES FOR IMPROVING RADIATION HARDNESS AND ELIMINATING LATCH-UP IN INTEGRATED CIRCUITS" ("APPLICATION"), which:

- will be filed; or
- was filed on _____ and was given Application No _____ by the following Office "_____";

Silicon Space Technology Corporation, a Delaware Corporation, D.B.A. Vorago Technologies, Inc., on behalf of itself and its successors and assigns ("ASSIGNEE"), is entitled to, and is desirous of acquiring, the entire and exclusive rights, title and interest, including the right of priority, in the INVENTION and the APPLICATION (and all other applications and patents derived therefrom, such as continuing applications, in whole or in part, in and for the United States, its territories, and all foreign countries ("APPLICATION DERIVATIVES"));

For good and valuable consideration, the receipt of which is hereby acknowledged by the ASSIGNOR, the ASSIGNOR hereby sells, assigns and transfers to the ASSIGNEE, ASSIGNOR's entire and exclusive rights, title and interest, including the right of priority, in the INVENTION and the APPLICATION (and all other applications and patents derived therefrom, such as continuing applications, in whole or in part, in and for the United States, its territories, and all foreign countries ("APPLICATION DERIVATIVES"));

ASSIGNOR agrees to execute all instruments and documents required for the making and prosecution of the APPLICATION (and APPLICATION DERIVATIVES), for litigation regarding letters patent derived therefrom, and for the purpose of protecting and perfecting title to the APPLICATION (and APPLICATION DERIVATIVES).

	<u>10/25/18</u>
Inventor's Signature	Date
Patrice M. Parris	
Printed Name in English	Printed Name in Native Language (if other than English)